MA6X125 (MA125)

Silicon epitaxial planar type

For switching circuit

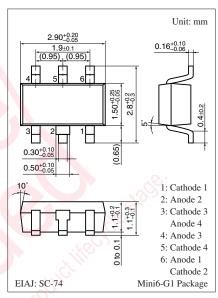
■ Features

 Four isolated elements contained in one package, allowing highdensity mounting

■ Absolute Maximum Ratings $T_a = 25$ °C

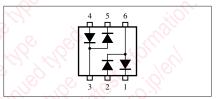
Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	40	V
Maximum peak reverse voltage	V_{RM}	40	V
Forward current *	I_{F}	100	mA
Peak forward current *	I_{FM}	200	mA
Junction temperature	T _j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

Note) *: Value for single diode



Marking Symbol: M2I

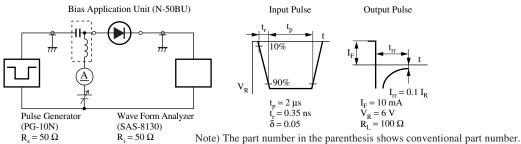
Internal Connection



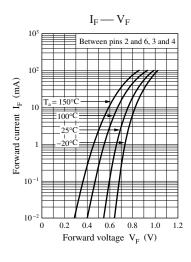
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

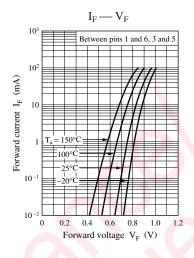
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 100 \text{ mA}$	SO C		1.2	V
Reverse voltage	V_R	$I_R = 100 \mu A$	40)		V
Reverse current	I_R	$V_R = 40 \text{ V}$	0.6		100	nA
Terminal capacitance	C _t	$V_R = 0 V, f = 1 MHz$			5.0	pF
Reverse recovery time *3	t _{rr1} *1	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$		150		ns
40/10	t _{rr2} *2	$I_{rr} = 0.1 I_R, R_L = 100 \Omega$		9		

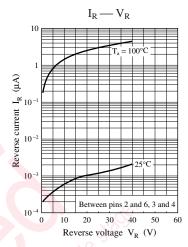
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: Between pins 1 and 6, Between pins 3 and 5
 - *2: Between pins 2 and 6, Between pins 3 and 4
 - *3: t_{rr} measurement circuit

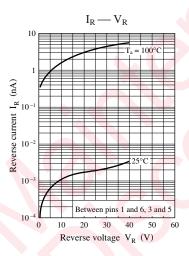


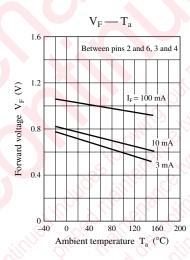
Panasonic

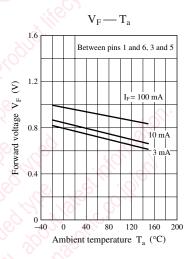


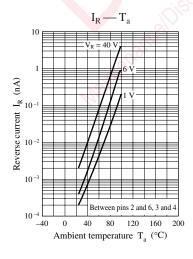


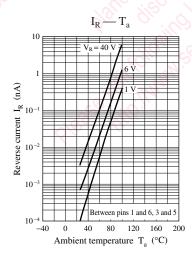


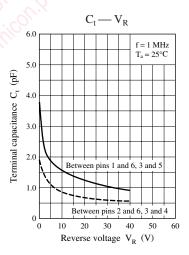




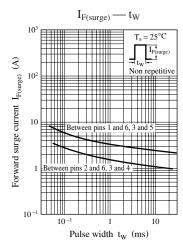








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